Impact of Proton and Neutron Irradiation on Carrier Transport Properties in GA2O3

Andrew C. Silverman
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IMPACT OF PROTON AND NEUTRON IRRADIATION ON CARRIER TRANSPORT PROPERTIES IN GA$_2$O$_3$

by

ANDREW C. SILVERMAN

A thesis submitted in partial fulfilment of the requirements for the Honors in the Major Program in Physics in the College of Sciences and in the Burnett Honors College at the University of Central Florida

Spring Term
2022

Thesis Chair: Dr. Elena Flitsiyan
This project studies the properties of minority charge carriers in beta gallium oxide (β-Ga₂O₃). The behavior of minority carriers is of high importance as it greatly affects conduction and consequently device performance. Cathodoluminescence (CL) spectroscopy and EBIC (Electron Beam Induced Current) are the main experimental techniques used to study minority carrier behavior.

High energy radiation affects minority carrier properties through damage to the material and through the production of carrier traps that reduce the conductivity and mobility of the material. In this investigation, we study the effects of various kinds of high energy radiation on properties of minority carriers in silicon-doped β-Ga₂O₃. The thermal activation energy of the reference (non-irradiated) sample was 40.9 meV, which is ascribed to silicon-donors. CL measurements indicate a slightly indirect bandgap energy of 4.9 eV. Under 10 MeV proton irradiation, the thermal activation energies increase. This increase is attributable to high order defects and their influence on carrier lifetimes. Differentiating itself from other forms of radiation, neutron irradiation creates disordered regions in β-Ga₂O₃ as opposed to just point defects, resulting in the lowest carrier removal rate because of the lowest average non-ionizing energy loss.

Measurements show that β-Ga₂O₃ is more resistant to radiation damage than some other wide bandgap semiconductors due to its higher displacement threshold energy, which is inversely proportional to the lattice constant.
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I would like to thank Dr. Robert Peale for his support of this project through his committee role. I am also thankful for his advice and support through the graduate school applications process, without which my current opportunities would not be available.

I am thankful to my family for their unconditional support both during this project, and more generally throughout my academic career.

Finally, I am thankful to God for the myriad blessings and opportunities afforded to me both professionally and personally.
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CHAPTER 1: INTRODUCTION AND BACKGROUND

Semiconductors, Recombination, and Charge Carriers

Semiconductors are the foundation upon which the majority of modern technology is built. They can possess various interesting attributes including biases that allow electrical currents to flow more easily in one direction than another, variable resistances, and other useful properties.

Generally, semiconductors are characterized by their resistivity at room temperature, usually possessing the trait that their conductivity increases with temperature contrary to the behavior of most standard metals[4]. In a lattice structure, electrons can reside either in the valence energy band, or the conduction energy band where electrons move freely throughout the lattice. These bands are sometimes separated by a physically forbidden energy range referred to as a bandgap. In silicon, this bandgap is relatively narrow which allows electrons to be excited and enter the conduction band with even a small amount of heat/energy introduced into the system.

Of particular interest and relevance for all applications of semiconductors is the electrical conductivity of a given sample. The conductivity in a semiconductor depends directly on the number of free charge carriers that it contains[5]. Charge carriers are either free electrons or holes, holes being positively charged spaces left behind when free electrons move from their rest positions in the valence band. One can increase the number of carriers by introducing impurities to the lattice in a process called doping. For instance, when an
astatine atom is introduced into a pure silicon lattice, there is an extra valence electron relative to silicon that is then free to move in the lattice[6].

When an electron is in the conduction band, it can interact with a hole in the valence band in a process called recombination. Energy is released in this process since the electron that was initially in the conduction band drops to a lower energy state in the valence band after recombination. The converse process can occur as well. Given sufficient excitation, an electron can free itself from the valence band and jump into the conduction band.

If the sample is not perfectly pure (like any sample in the real world), then it will contain various impurities and defects such as excess semiconductor atoms breaking lattice symmetry, missing semiconductor atoms breaking lattice symmetry, or non-semiconductor atoms such as various metals or oxygen throughout. These imperfections can create permitted energy levels located within the semiconductor’s characteristic bandgap range of energies. Shockley-Read Hall (SRH) recombination is recombination that occurs at one of these newly accessible energy levels[5].

In doped semiconductors, there is not an equal number of electrons and holes present in a given sample. For n-type semiconductors, there are more electrons than holes. In this case, holes are referred to as minority charge carriers. For p-type semiconductors, this is reversed, and the greater number of holes designates the electrons as the minority charge carriers.
Gallium(III) Oxide ($\text{Ga}_2\text{O}_3$)

Semiconductors with narrow bandgaps, primarily silicon, have dominated applications since the advent of the transistor. However, in recent decades there has been growing interest in semiconductors with bandgaps wider than that of the usual options. Their wider bandgap energies make them particularly interesting for high power and high temperature applications. This is due to silicon-based devices often struggling to perform as intended under such harsh conditions.

Beta gallium oxide ($\beta$-$\text{Ga}_2\text{O}_3$) is a particularly promising example of an ultra-wide bandgap (UWBG) semiconductor for applications in power switching electronics [7–12]. The leading motivations for the study of new UWBG semiconductors such as $\text{Ga}_2\text{O}_3$, BN, and high-Al AlGaN are chiefly the reduction of size, cost, and switching speeds in electronics [8, 12]. The bandgap of $\beta$-$\text{Ga}_2\text{O}_3$ is 4.8-4.9 eV and has an estimated critical field strength of 8 MV/cm [7, 9, 10, 12]. A bandgap of this width permits the extension of device operation into higher temperature ranges, while the magnitude of the critical field allows for operation under higher voltages [11]. The valence band is mostly flat in momentum space, which results in a very large effective mass for holes in the material, which leads to the formation of local polarons (holes confined by lattice distortions) [7, 10]. This results in one of the drawbacks of using $\beta$-$\text{Ga}_2\text{O}_3$ as a semiconductor, the difficulty of p-type doping of the material. Also, the thermal conductivity ($\kappa\kappa$) is approximately an order of magnitude lower than that of both SiC and GaN, and approximately half that of sapphire [12]. Finding ways to mitigate this issue such as the employment of diamond or sapphire substrates, topside active cooling, and structural variations have been of great research interest.
The resilience of wide bandgap materials is particularly advantageous in environments characterized by high temperatures and radiation dosages [3, 13–29]. In potential applications, $\beta$-Ga$_2$O$_3$-based electronics could be subjected to high energy cosmic rays, $\alpha$-particles and electrons in low-Earth orbit satellites, and high energy neutron and gamma radiation in nuclear and military applications. The bonds between the gallium and oxygen atoms in $\beta$-Ga$_2$O$_3$ are extremely strong, resulting in materials based on it being quite resistant to radiation under total dose conditions [3, 20–29]. In the course of the investigation, $\beta$-Ga$_2$O$_3$ devices were irradiated with electrons, protons, alpha particles, neutrons, and gamma rays. The degradation to the devices is measured, but the degradation’s functional dependence on energy and dosage remains to be confirmed. Each variety of radiation dosage inflicts differing kinds of damage on the crystal lattices [13, 14, 29]. Additionally, primary lattice defects can recombine and and form complexes with each other, dopants, and with extended defects [29].

In past investigations, most experiments studying the irradiation of $\beta$-Ga$_2$O$_3$ have been conducted using protons and $\alpha$-particles since these are easier to model theoretically and perform in the lab [13]. There is comparatively little known about the effects of neutron irradiation. The effects of fast neutron irradiation on the electrical conductivity of $\beta$-Ga$_2$O$_3$ was reported by Cojocaru [30]. In that investigation, the electrical conductivity was found to decrease given a dose of $10^{17}$ cm$^{-2}$. This was explained theoretically by assuming that the lattice defects acted as electron traps. At 1000 K, the defects annealed out with an activation energy of 2 eV. $\beta$-Ga$_2$O$_3$ was irradiated with 2 MeV neutrons to a fluence of $4 \times 10^{15}$ cm$^{-2}$ by Farzana et al. [24]. This resulted in a decrease in reverse current in rectifier structures, a loss of carriers at a rate of approximately 20 cm$^{-1}$, and the
introduction of a deep trap state at -1.88 eV observed in deep level transient spectroscopy (DLTS) measurements. This was ascribed to an oxygen-vacancy related state. A linear increase with pulsed neutron fluence of the density of deep electron traps E2 (E_c - 1.05 eV), E3 (E_c - 1.05 eV), and E4 (E_c - 1.2 eV) admitting an introduction rate of approximately 0.5 cm^{-1} was observed.

The utility of Ga_2O_3 for detection of fast (14 MeV) neutrons using the ^{16}\text{O} (n, \alpha)^{13}\text{C} reaction was investigated as well [27]. Under these conditions, fast neutrons could be detected, but with insufficient resolution for spectroscopy applications. Chaiken and Blue [25] reported the displacement cross-section for Ga_2O_3 subjected to neutron irradiation. The curve has a low energy cutoff since the analysis is cutoff at the neutron energy for which the maximum transferred energy is less than the threshold. The displacement damage cross-section was \sigma(Ga_2O_3_{\text{disp}})(1 \text{ MeV}) = 92.3 \text{ MeVmb}, assuming a given displacement threshold energy in Ga_2O_3 of E_{\text{Ga, d}} = 25 \text{ eV} [25]. This is useful for classifying and comparing the effects of neutron irradiation under differing fluences and energies. Farzana et al. [24] characterized deep traps in bulk n-type Sn-doped Ga_2O_3 subjected to neutron irradiation up to fluences of 2 \times 10^{15} \text{ cm}^{-2}. An increase in concentration of electron traps E3 (E_c - 1.05 eV) and E1 (E_c - 0.65 eV) in DLTS and an increase in the occurrence of hole traps with an optical threshold approaching 2 eV was observed, which is in general agreement with the results that have been reported for proton-irradiated crystals [3, 24].

In this project, we report on the effects \alpha-particle radiation on the material properties of Ga_2O_3 rectifiers. The neutron sources consist of an alpha emitter (Am-241 in our case) mixed with a low Z material, usually ^9\text{Be}. Neutrons are emitted in the reaction:
\[ ^{9}\text{Be} + \alpha \rightarrow ^{12}\text{C} + \text{neutron} + \gamma (4.44 \text{ MeV}). \]

The energies commonly range up to 11 MeV, with an average energy of 4.2 MeV as shown in Figure 1.1. In Ga\(_2\)O\(_3\), the mean free path is over 10 cm, much larger than the thickness of the given samples [28]. The narrow scattering cross-section of \(\leq 0.5 \text{ cm}^{-1}\) suggests the average number of interactions per neutron is on the order of \(10^6\) reactions/cm\(^2\) for the drift region of the rectifier structure at the highest dosage condition.

Figure 1.1: Neutron energy spectrum from Am-Be source. The neutron energies in the Am-Be source range up to 11 MeV, with an average energy between 4 and 5 MeV.

\(\alpha\)-particles are emitted via radioactive decay of \(^{241}\text{Am}\) [31]. The half-life of the \(^{241}\text{Am}\) \(\alpha\)-emitter is around 400 years, so the intensity is generally unchanged over the course of the experiment. The resultant \(^{12}\text{C}\) nucleus emits 4.44 MeV gamma-rays along with the neutrons. Consequently, the \(^{241}\text{Am-Be}\) source can also be used as a mono-energetic high
energy gamma-ray source.

Figure 1.2: Decay-diagram of $^{12}\text{C}$

It is found that the reverse current and on/off ratio in the Ga$_2$O$_3$ rectifiers are sensitive to neutron doses around $5 \times 10^{12}$ cm$^{-2}$, characterized by carrier removal rates of approximately 0.480 cm$^{-1}$. The reverse recovery time ($\sim$27 ns) and the diode ideality factor were unaffected by doses in this range.

In order to estimate the exact neutron dosage in the sample, reference activation foils with well-known cross-sections in the given energy ranges were used. The threshold cross-sections and reaction types of the activated elements are shown in table 1.1 on the following page.
<table>
<thead>
<tr>
<th>Nucleus</th>
<th>Nuclear Reaction</th>
<th>Reaction Threshold (MeV)</th>
</tr>
</thead>
<tbody>
<tr>
<td>$^{115}\text{In}$</td>
<td>(n, n$'$)</td>
<td>0.8</td>
</tr>
<tr>
<td>$^{111}\text{Cd}$</td>
<td>(n, n$'$)</td>
<td>0.9</td>
</tr>
<tr>
<td>$^{64}\text{Zn}$</td>
<td>(n, p)</td>
<td>2.5</td>
</tr>
<tr>
<td>$^{27}\text{Al}$</td>
<td>(n, p)</td>
<td>4.2</td>
</tr>
<tr>
<td>$^{27}\text{Al}$</td>
<td>(n, α)</td>
<td>7.0</td>
</tr>
</tbody>
</table>

Table 1.1: Activation Foils

Experimental Information

The fabrication sequence for the Schottky rectifiers began with a layer structure of 10 µm Si-doped ($3.5 \times 10^{16}$ cm$^{-3}$) epitaxial layer grown by Halide Vapor Epitaxy (HVPE) on an (001) oriented 650 µm β-phase Sn-doped ($n = 3.6 \times 10^{18}$ cm$^{-3}$) Ga$_2$O$_3$ substrate (Novel Crystal Technology). A full area backside Ohmic contact (20 nm / 80 nm, Ti / Au) was deposited by electron beam evaporation and annealed for 30 s at 550° C in N$_2$ in a rapid thermal annealer. To form a field plate, 40 nm Al$_2$O$_3$ and 360 nm SiNx dielectric were deposited using Atomic Layer Deposition and Plasma Enhanced Chemical Vapor Deposition respectively. Windows with 100 µm diameter were opened using 1:10 diluted Buffered Oxide Etchant (BOE). The sample surface was then treated in O$_3$ for 20 minutes to remove contamination species including hydrocarbons. 400 µm Ni/Au (80 nm/320 nm) Schottky metal was subsequently deposited using electron beam evaporation with standard acetone lift-off.

The samples were exposed to the neutron source at cumulative doses of $10^{12}$ or $5 \times 10^{12}$ cm$^{-2}$. They were then characterized for changes in various parameters including current-
voltage (I-V), capacitance-voltage (C-V), reverse recovery, on/off ratio, Schottky barrier height and diode ideality factor with the forward I-V characteristics, Cathodoluminescent (CL) spectrum, and EBIC (Electron Beam Induced Current) techniques.
CHAPTER 2: RESULTS AND ANALYSIS

Electrical Measurements

In Figure 2.1, we have the I-V characteristic before and after two doses of neutron radiation. The forward portion of the characteristic exhibits no measurable change after irradiation, with the Schottky barrier height maintaining its initial value of $0.76 \pm 0.05$ eV, and the diode ideality factor invariant at $1.15 \pm 0.03$. The on-state resistance also remained at its reference value of $3.5 \pm 0.1$ m$\Omega$cm$^2$. However, the reverse current was found to increase for both doses, as seen in the bottom of Figure 2.1. This indicates the formation of recombination centers that increased the reverse current, which itself is fixed by the sum of the saturation and generation currents in the sample. The primary displacement defects introduced in the irradiation of Ga$_2$O$_3$ are expected to be oxygen and gallium vacancies [27–30, 32]. The former are deep donors, and thus do not induce n-type conductivity at standard temperatures in Ga$_2$O$_3$. The gallium vacancies are triple acceptors, which can compensate for the background n-type conductivity in Ga$_2$O$_3$. Kananen et al. [32] irradiated a sample with high energy neutrons, which created vacancies and lowered the Fermi energy below the (2-/3-) level. This results in the $V_{Ga}^{2-}$ defect, which has one unpaired spin-$\frac{1}{2}$ located on one of the O(I) atoms near the vacancy [8]. Positron annihilation experiments have confirmed that $V_{Ga}$ is a compensating acceptor in n-type Ga$_2$O$_3$ [8].
Figure 2.1: I-V Characteristic before and after two neutron doses.

Figure 2.2:
- I-V characteristics from rectifiers before and after neutron irradiation at two different doses. (top)
- Reverse I-V characteristics from same devices (bottom).

In Figure 2.2, it is shown in the C2-V characteristics that carrier concentration in the drift region of the rectifiers was decreased upon irradiation. From the slope of these plots, we
extract carrier concentrations of $1.36 \times 10^{16}$ cm$^{-3}$ in the reference device, and $1.18 \times 10^{16}$ cm$^{-3}$ and $1.12 \times 10^{12}$ cm$^{-3}$ respectively for the doses of $10^{12}$ and $5 \times 10^{12}$ cm$^2$. The effective carrier removal rate throughout was 480 cm$^{-1}$. The compensation of the n-type doping indicates that acceptors were created upon neutron irradiation, consistent with the observation regarding $V_{Ga}$ earlier on.

In Figure 2.4, the rectifier on/off ratio is measured at 1V forward, and then reverse biases in the range of 0-100 V are shown. A clear decrease in this parameter is observed for the higher neutron dosage due to the more extreme increase in reverse current.

This is in sharp contrast with Figure 2.5. Here, the reverse recovery time when switching from +1 V forward to -10 V reverse bias voltage is invariant with respect to neutron flux over the investigated range and remains at 27 ns for all rectifiers.

![Figure 2.3: Rectifier C2-V characteristics before and after neutron irradiation at varying doses](image)

Figure 2.3: Rectifier C2-V characteristics before and after neutron irradiation at varying doses
Figure 2.4: On/off ratio for rectifiers as a function of reverse voltage for differing neutron doses

Figure 2.5: Switching characteristics of rectifiers 1V forward bias to -50 V reverse bias before and after different neutron doses
Another topic of interest is the comparison between the results of neutron irradiation from the Am-Be source, with other reports in the literature using varying neutron energies and other kinds of radiation [29]. Below, Figure 2.6 displays a compilation of this data. It should be noted that there is some inherent uncertainty in the reported values. This is due to the fact that it is not always clear that the removal rates were measured under conditions with linear dosage and moreover, high levels of compensating impurities or of extended defects created during the irradiation process can also affect the effective removal rate [15–17, 19]. However, it is clear that gamma and electron radiation are the least damaging to Ga$_2$O$_3$ while alpha particles are the most damaging. The reported value for neutrons with an average energy of 4.2 MeV is roughly 20 times higher than for neutrons with an average energy of 1 MeV.

![Figure 2.6: Carrier removal rates for neutrons in this experiment compared to previous reports for different forms of radiation](image)

Figure 2.6: Carrier removal rates for neutrons in this experiment compared to previous reports for different forms of radiation
Measurement and Analysis of Minority Carrier Properties

**CL Measurements**

In this section, we study the effects of high energy radiation on minority carrier diffusion lengths in silicon-doped $\beta$-Ga$_2$O$_3$. The thermal activation energy found in the non-irradiated samples was 40.9 meV. Cathodoluminescence measurements indicate a slightly indirect bandgap energy of 4.9 eV. Under electron radiation of 1.5 MeV, activation energies are found to decrease. Alternatively, they increase under 10 MeV proton irradiation. The higher activation energy under proton irradiation is ascribable to high order lattice defects that affect carrier lifetimes. In-situ CL measurements were performed with a SEM.

![Cathodoluminescence Apparatus](image)

Figure 2.7: Cathodoluminescence Apparatus. Light impacts curved mirror (b), is redirected into light guide (c), which feeds into a spectrometer/monochromator, (d). the spectrometer/monochromator output then goes to a PMT or CCD, (e) this output then is sent to a local computer (f). [1]

Charge traps have an activation energy that is obtained through recording intensity, as there exists a convenient relation between the CL intensity ($I_{CL}$) and temperature:

15
\[ I_{CL}(T) = \frac{A}{1 + B \exp(-\frac{E_\alpha}{k_B T})} \]  \hspace{1cm} (2.1)

where \( E_\alpha \) is the carrier activation energy and A and B are scaling constants. A constant temperature is maintained for at least five minutes before any data is collected during the measurement process. At equilibrium, there is a direct proportional relation between CL intensity and temperature, and an inverse proportional relation between the CL intensity and the minority carrier lifetime.

Interactions with the electron beam can cause traps to become occupied over time and affect the observed intensity. This leads to a time dependence of the CL intensity. Given that \( I_{CL} \) is inversely proportional to minority carrier lifetime, it can be found that:

\[ I_{CL}^{-1} \propto \tau = \frac{L_0^2}{D} \exp\left( -\frac{E_\alpha}{k_B T} \right) \]  \hspace{1cm} (2.2)

which also implies that \( L_0 \) has a nontrivial time dependence under continual excitation from the electron beam [33]. The rate that \( L_0 \) grows can then be found by recording the intensity as the temperature varies. One can then find a rate given by:

\[ R(T) = R_0 \exp\left( -\frac{E_\alpha}{k_B T} \right) \]  \hspace{1cm} (2.3)

where \( R_0 \) is an arbitrary constant.
There have also been investigations of various optical properties given varying dopants. Dopant atoms with a charge magnitude greater than three resulted in an emission around 380 to 400 nm, and both beryllium and lithium result in emission around 500 nm [34].

Emission properties of $\beta$-Ga$_2$O$_3$ have also been studied to determine dopant species and concentrations [34, 35]. Dopant atoms with a charge magnitude greater than three resulted in an emission near 380-400 nm and doping with either beryllium or lithium result in emission around 500 nm [34].

\section*{CL Investigation of Neutron Irradiated Ga$_2$O$_3$ Structures}

\begin{figure}[h]
\centering
\includegraphics[width=0.8\textwidth]{figure2.8.png}
\caption{Spectral Comparison – Diode. There is a reliable observation that the intensity is higher for the sample with the larger neutron dose.}
\end{figure}

Gallium oxide’s bandgap is usually assumed to be direct and is around 4.9 eV, and measurements place the cutoff wavelength at approximately 259 nm [34, 36]. However, $\beta$-Ga$_2$O$_3$’s bandgap is slightly indirect and there is no emission at the bandgap energy. The
other bands with observable emissions lie below the bandgap energy and are approximated as Gaussian energy bands. The 3.65 eV band is attributable to charge transitions one of the oxygen vacancies [37], the 3.25 eV band is associated to free electrons recombining with self-trapped holes [38], and the band at 2.9 eV is associated to donor-acceptor pairs [36].

The dominant peak was measured at approximately 380 nm, and the the CL emission data with a Gaussian fit is presented below:

Figure 2.9: Continuous wave $\beta$-Ga$_2$O$_3$ CL collected at room temperature and 6 kV accelerating voltage presented with Gaussian breakdown. The main window presents the normalized intensity spectrum (gray circles) from 300 to 600 nm with the estimated Gaussian peaks centered at 3.65 (dotted), 3.25 (dot-dashed), 2.90 eV (dashed), and the sum of the Gaussian peaks (solid). The inset presents the spectrum from 200 to 320 nm showing absence of bandgap emission [2].

In figure 2.9, it can be seen that there is no emission at 4.9 eV, which is consistent with previous studies. The CL intensity was shown to change with accelerating voltage, and this is shown below in Figure 2.10.
<table>
<thead>
<tr>
<th>Band Energy</th>
<th>( a_i ) (a.u.)</th>
<th>( b_i ) (eV)</th>
<th>( c_i ) (eV)</th>
<th>FWHM_i (eV)</th>
</tr>
</thead>
<tbody>
<tr>
<td>( E_1 = 3.65 ) eV</td>
<td>0.13</td>
<td>3.65</td>
<td>0.31</td>
<td>0.52</td>
</tr>
<tr>
<td>( E_2 = 3.25 ) eV</td>
<td>0.86</td>
<td>3.25</td>
<td>0.33</td>
<td>0.55</td>
</tr>
<tr>
<td>( E_3 = 2.90 ) eV</td>
<td>0.25</td>
<td>2.90</td>
<td>0.36</td>
<td>0.60</td>
</tr>
</tbody>
</table>

Table 2.1: Parameters for Gaussian deconvolution of continuous wave CL emission of \( \beta \)-Ga\(_2\)O\(_3\) [1].

Also presented are emission spectra out to further wavelength values, exhibiting a band at approximately 680 nm due to defects. The current value of the beam for the 6 and 8 kV values are nearly the same, while their associated emission values are not. Consequently, it is concluded that the dependence of CL intensity on accelerating voltage is significant. This can be explained by noting that the generation volume of the system may enclose carriers that are capable of radiative recombination.

Figure 2.10: CL spectra for Si-doped \( \beta \)-Ga\(_2\)O\(_3\) under accelerating voltage. The main peak was measured at approximately 380 nm, and vertical is log-scaled to ensure the visibility of the 680 nm band [1].

A spectral comparison of intensities observed in FET’s under varying neutron dosages is
also given below.

Figure 2.11: Spectral Comparison – FET
It is observed that the intensity is higher for the sample with the larger neutron dose. The FET specimens emit a peak around 247 nm which is not seen in the diode specimens, while the band centered around 400 nm is present in both specimen types.

Effects of 10 MeV Proton Irradiation

The rates of carrier removal in $\beta$-Ga$_2$O$_3$ dosed with proton radiation are found to be close to those of GaN with similar doping under comparable dosage conditions [39, 40]. The most common defect to arise in Ga$_2$O$_3$ under these conditions is a gallium vacancy with two hydrogens [41].

The electron beam induced current method was used to find the minority carrier diffusion length ($L$) before and after dosage. At room temperature, $L$ was approximately 340 nm in the reference sample. This value decreased with increases in temperature. After the dosage with proton radiation, the value of $L$ at room temperature decreased to approxi-
mately 315 nm. For the reference sample, the activation energy was 41.8 meV and \( L_0 \) was approximately 145 nm. For the irradiated sample, these values approached 16.2 meV and 228 nm respectively.

![Figure 2.12: Minority carrier diffusion length in Si-doped \( \beta \)-Ga\(_2\)O\(_3\) for both reference and 10 MeV proton-irradiated sample. [3]](image)

The diffusion length’s dependence on temperature implies that the defects tend to protect it against reduction due to temperature at temperatures greater than 60 °C.

<table>
<thead>
<tr>
<th>Fluence</th>
<th>( n ) (cm(^{-3}))</th>
<th>( L ) (nm)</th>
<th>( L_0 ) (nm)</th>
<th>( E_a ) (meV)</th>
<th>( \tau ) (ps)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0 (Reference Sample)</td>
<td>( 3.1 \times 10^{16} )</td>
<td>340 ± 22</td>
<td>145</td>
<td>41.8</td>
<td>215 ± 22</td>
</tr>
<tr>
<td>( 1 \times 10^{14} )</td>
<td>( 8.03 \times 10^{15} )</td>
<td>315 ± 16</td>
<td>228</td>
<td>16.2</td>
<td>300 ± 35</td>
</tr>
</tbody>
</table>

Table 2.2: Properties of Si-doped \( \beta \)-Ga\(_2\)O\(_3\) upon 10 MeV proton irradiation [3].

Removal of carriers in the epilayer through non-ionizing energy loss was observed. This resulted in the creation of both electron traps, and hole acceptors, which served to com-
pensate for the doping. The rate of carrier removal was calculated to be 235.7 cm$^{-1}$ under dosage. Also, carrier density dropped from an initial $3.1 \times 10^{16}$ cm$^{-3}$ to $8.03 \times 10^{15}$ cm$^{-3}$ after dosage. This was restored to $1.87 \times 10^{16}$ cm$^{-3}$ after annealing at 300 °C.
CHAPTER 3: CONCLUSION

There is an observed decrease in the diffusion length of minority carriers with decreases in temperature in all $\beta$-Ga$_2$O$_3$ samples. This is not what happens in GaN [18] but is consistent with results for Si and GaP [25]. When the samples are subjected to high energy electron and proton irradiation, the diffusion lengths of minority carriers decreases. The activation energies are close to the ionization energy of donors in previous $\beta$-Ga$_2$O$_3$ studies [42–46].
LIST OF REFERENCES


[20] Jiancheng Yang, Fan Ren, Stephen J. Pearton, Gwangseok Yang, Jihyun Kim, and Akito Kuramata. 1.5MeV electron irradiation damage in $\beta$-Ga$_2$O$_3$ vertical rectifiers.


